

Agilent HCPL-250L/ 050L/253L/053L LVTTL/LVCMOS Compatible 3.3 V Optocouplers (1 Mb/s)

Data Sheet

Description

These diode-transistor optocouplers use an insulating layer between a LED and an integrated photodetector to provide electrical insulation between input and output. Separate connections for the photodiode bias and output-transistor collector increase the speed up to a hundred times that of a conventional phototransistor coupler by reducing the base-collector capacitance.

These optocouplers are available in an 8-pin DIP and in an industry standard SO-8 package. The following is a cross reference table listing the 8-pin DIP part number and the electrically equivalent SO-8 part number.

The SO-8 does not require "through holes" in a PCB. This package occupies approximately one-third the footprint area of the

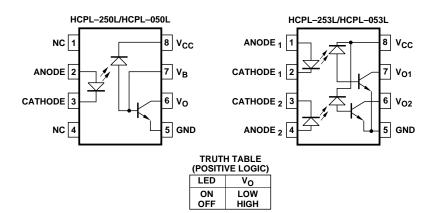
Features

- Low power consumption
- High speed: 1 Mb/s
- LVTTL/LVCMOS compatible
- Available in 8-pin DIP, SO-8
- Open collector output
- Guaranteed performance from temperature: 0°C to +70°C
- Safety approval, UL, CSA, VDE (pending)

Applications

- High voltage insulation
- Video signal isolation
- Power translator isolation in motor drives
- Line receivers
- Feedback element in switched mode power supplies
- High speed logic ground isolation LVTTL/LVCMOS
- Replaces pulse transformers
- Replaces slow phototransistor isolators
- Analog signal ground isolation

Functional Diagram



A 0.1 µF bypass capacitor must be connected between pins 5 and 8.

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.



standard dual-in-line package. The lead profile is designed to be compatible with standard surface mount processes.

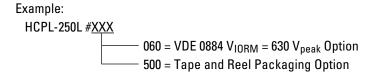
These optocouplers can be used in LVTTL/LVCMOS or wide bandwidth analog applications.

The common mode transient immunity of 15,000 V/ μ s minimum at V_{CM} = 1500 V guaranteed for these optocouplers.

| 8-Pin DIP | SO-8 Package |
|-----------|--------------|
| HCPL-250L | HCPL-050L |
| HCPL-253L | HCPL-053L |

Ordering Information

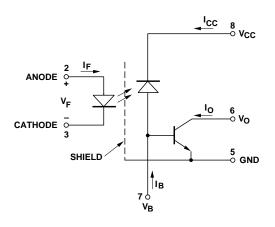
Specify Part Number followed by Option Number (if desired).



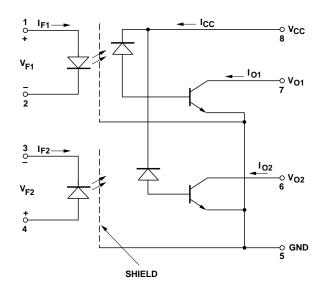
Option data sheets available. Contact Agilent sales representative or authorized distributor for information.

Schematic

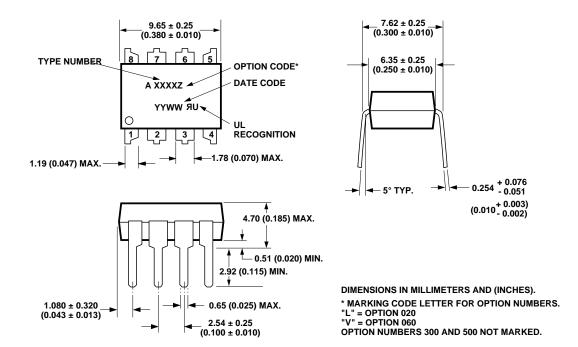
HCPL-250L/HCPL-050L



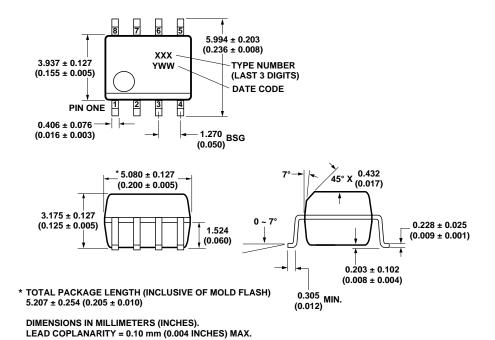
HCPL-253L/HCPL-053L



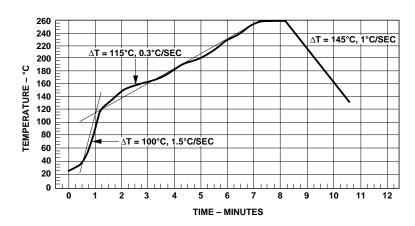
Package Outline Drawings 8-Pin DIP Package



Small Outline SO-8 Package



Solder Reflow Temperature Profile (Surface Mount Option Parts)



(NOTE: USE OF NON-CHLORINE ACTIVATED FLUXES IS RECOMMENDED.)

Regulatory Information

The devices contained in this data sheet are pending by the following organizations:

UL

Approval (pending) under UL 1577, Component Recognition Program, File E55361.

CSA

Approval (pending) under CSA Component Acceptance Notice #5, File CA 88324.

VDE

Approval (pending) according to VDE 0884/06.92.

Insulation and Safety Related Specifications

| Parameter | Symbol | 8-Pin DIP (300 Mil) Value | SO-8 Value | Units | Conditions |
|--|---------|---------------------------------|---------------|-------|--|
| Minimum External Air Gap (External Clearance) | L (101) | 7.1 | 4.9 | mm | Measured from input terminals to output terminals, shortest distance through air. |
| Minimum External Tracking (External Creepage) | L (102) | 7.4 | 4.8 | mm | Measured from input terminals to output terminals, shortest distance path along body. |
| Minimum Internal Plastic Gap (Internal Clearance) | | 0.08 | 0.08 | mm | Through insulation distance, conductor to conductor, usually the direct distance between the photoemitter and photodetector inside the optocoupler cavity. |
| Minimum Internal Tracking (Internal Creepage) | | NA | NA | mm | Measured from input terminals to output terminals, along internal cavity. |
| Tracking Resistance (Comparative Tracking Index) | СТІ | 200 | 200 | Volts | DIN IEC 112/VDE 0303 Part 1. |
| Isolation Group | | Illa | Illa | | Material Group (DIN VDE 0110, 1/89, Table 1). |

VDE 0884 Insulation Related Characteristics

| Description | Symbol | Characteristic | Units |
|--|-----------------------|-------------------|-------------------|
| Installation classification per DIN VDE 0110/1.89, Table 1 | | | |
| for rated mains voltage ≤ 300 V rms | | I-IV | |
| for rated mains voltage \leq 450 V rms | | 1-111 | |
| Climatic Classification | | 55/100/21 | |
| Pollution Degree (DIN VDE 0110/1.89) | | 2 | |
| Maximum Working Insulation Voltage | V _{IORM} | 630 | V _{peak} |
| Input to Output Test Voltage, Method b* | | | |
| V_{IORM} x 1.875 = V_{PR} , 100% Production Test with t_m = 1 sec, | V _{PR} | 1181 | V_{peak} |
| Partial Discharge < 5 pC | | | |
| Input to Output Test Voltage, Method a* | | | |
| V_{IORM} x 1.5 = V_{PR} , Type and Sample Test, | V_{PR} | 945 | V _{peak} |
| t _m = 60 sec, Partial Discharge < 5 pC | | | |
| Highest Allowable Overvoltage* | V _{IOTM} | 6000 | V _{peak} |
| (Transient Overvoltage, t _{ini} = 10 sec) | | | F |
| Safety Limiting Values | | | |
| (Maximum values allowed in the event of a failure, | | | |
| also see Figure 4, Thermal Derating curve.) | | | |
| Case Temperature | T _S | 175 | °C |
| Input Current | I _{S,INPUT} | 230 | mA |
| Output Power | P _{S,OUTPUT} | 600 | mW |
| Insulation Resistance at T _S , V _{IO} = 500 V | R _S | ≥ 10 ⁹ | Ω |

^{*}Refer to the front of the optocoupler section of the current catalog, under Product Safety Regulations section (VDE 0884), for a detailed description.

Note: Isolation characteristics are guaranteed only within the safety maximum ratings which must be ensured by protective circuits in application.

Absolute Maximum Ratings

| Parameter | Symbol | Min. | Max. | Units | Note |
|---|-----------------------|---------|-----------------|--------|------|
| Storage Temperature | T _S | -55 | 125 | °C | |
| Operating Temperature | T _A | -55 | 100 | °C | |
| | | -55 | 85 | | |
| Average Forward Input Current | I _{F(AVG)} | | 25 | mA | 1 |
| Peak Forward Input Current | I _{F(PEAK)} | | | | 2 |
| (50% duty cycle, 1 ms pulse width) | | | 50 | mA | |
| (50% duty cycle, 1 ms pulse width) | | | 40 | | |
| Peak Transient Input Current | I _{F(TRANS)} | | 1 | Α | |
| $(\leq 1 \mu s \text{ pulse width, 300 pps})$ | | | | | |
| | | | 0.1 | | |
| Reverse LED Input Voltage (Pin 3-2) | V _R | | 5 | V | |
| | | | 3 | | |
| Input Power Dissipation | P _{IN} | | 45 | mW | 3 |
| | | | 40 | | |
| Average Output Current (Pin 6) | I _{O(AVG)} | | 8 | mA | |
| Peak Output Current | I _{O(PEAK)} | | 16 | mA | |
| Emitter-Base Reverse Voltage | V _{EBR} | | 5 | V | |
| Supply Voltage (Pin 8-5) | V _{CC} | -0.5 | 7 | V | |
| Output Voltage (Pin 6-5) | V ₀ | -0.5 | 7 | V | |
| Base Current | I _B | | 5 | mA | |
| Output Power Dissipation | P ₀ | | 100 | mW | 4 |
| Lead Solder Temperature | | | | | |
| (Through Hole Parts Only) | | | | | |
| 1.6 mm below seating plane, 10 sec. | T _{LS} | | 260 | °C | |
| up to seating plane, 10 seconds | | | 260 | °C | |
| Reflow Temperature Profile | T _{RP} | | age Outline Dra | awings | |
| | | section | | | |

Recommended Operating Conditions

| Parameter | Symbol | Min. | Max. | Units |
|-----------------------|---------------------|------|------|-------|
| Power Supply Voltage | V _{CC} | 2.7 | 3.3 | V |
| Forward Input Current | I _{F(ON)} | 16 | 20 | mA |
| Forward Input Voltage | V _{F(OFF)} | 0 | 0.8 | V |
| Operating Temperature | T _A | 0 | 85 | °C |

Electrical Specifications (DC) Over Recommended Temperature ($T_A = 0^{\circ}C$ to $+70^{\circ}C$), $V_{CC} = 3.3$ V, $I_F = 16$ mA, unless otherwise specified. See Note 13.

| Parameter | Sym. | Device | Min. | Тур. | Max. | Units % | Test Conditions | Fig. | Note |
|---------------------------------------|------------------|--------|------|-------|------|------------|---|------|-------|
| Current Transfer Ratio | CTR | | | | | | $T_A = 25^{\circ}C$ $V_0 = 0.4 \text{ V}$ $I_F = 16 \text{ mA},$ $V_{CC} = 3.3 \text{ V}$ | 2 | 5, 11 |
| | | | 15 | 20 | 50 | | | | |
| Logic Low | V_{OL} | | | | | ٧ | I _F = 16 mA, | | |
| Output Voltage | | | | | | | V _{CC} = 3.3 V | | |
| | | | | 0.05 | 0.3 | | $T_A = 25^{\circ}C$ $I_0 = 3.0 \text{ mA}$ | | |
| Logic High Output Current | I _{OH} | | | 0.003 | 1 | μΑ | $T_A = 25^{\circ}C$ $V_0 = V_{CC} = 3.3 \text{ V}$ $I_F = 0 \text{ mA}$ | 3 | |
| Logic Low | I _{CCL} | | | 43.0 | 100 | μΑ | $I_F = 16 \text{ mA}, V_0 = 0 \text{ pen}, V_{CC} = 3.3 \text{ V}$ | | 13 |
| Supply Current | | Dual | | | 300 | | | | |
| Logic High | I _{CCH} | | | 0.005 | 0.3 | μΑ | $T_A = 25^{\circ}C$ $I_F = 0 \text{ mA}, V_0 = 0 \text{ pen},$ | | 13 |
| Supply Current | | Dual | | | 10 | | V _{CC} = 3.3 V | | |
| Input Forward Voltage | V _F | | | 1.52 | 1.7 | V | $T_A = 25^{\circ}C$ $I_F = 16 \text{ mA}$ | 1 | |
| Input Reverse Breakdown Voltage | BV _R | | 5 | | | V | Ι _R = 10 μΑ | | |
| Input | C _{IN} | | | 60 | | pF | f = 1 MHz, V _F = 0 V | | |
| Capacitance | | | | 90 | | | | | |

Switching Specifications (AC) Over Recommended Temperature ($T_A = 0^{\circ}C$ to +70°C), $V_{CC} = 3.3$ V, $I_F = 16$ mA unless otherwise specified.

| Parameter | Sym. | Device | Min. | Тур.* | Max. | Units | Test Condition | ons | Fig. | Note |
|---|--------------------|--------|------|-------|------|-------|---|--|------|---------|
| Propagation Delay Time to Logic Low at Output | t _{PHL} | | | 0.35 | 1 | μs | T _A = 25°C | $R_L = 1.9 \text{ k}\Omega$ | 5 | 8, 9 |
| Propagation Delay Time to Logic High at Output | t _{PLH} | | | 0.65 | 1 | μs | T _A = 25°C | $R_L = 1.9 \text{ k}\Omega$ | 5 | 8, 9 |
| Common Mode Transient Immunity at Logic High Level Output | ICM _H I | | | 1 | | kV/μs | $R_L = 4.1 \text{ k}\Omega$ $R_L = 1.9 \text{ k}\Omega$ | $I_F = 0 \text{ mA}, T_A = 25^{\circ}\text{C},$ $V_{CM} = 10 V_{p-p}$ $C_L = 15 \text{ pF}$ | 6 | 7, 8, 9 |
| Common Mode Transient Immunity at Logic Low Level Output | ICMLI | | | 1 | | kV/μs | $R_L = 4.1 \text{ k}\Omega$ $R_L = 1.9 \text{ k}\Omega$ | $I_F = 16 \text{ mA}, T_A = 25^{\circ}\text{C},$ $V_{CM} = 10 V_{p-p}$ $C_L = 15 \text{ pF}$ | 6 | 7, 8, 9 |

^{*}All typicals at T_A = 25°C

Package Characteristics

Over Recommended Temperature ($T_A = 0^{\circ}C$ to $70^{\circ}C$) unless otherwise specified.

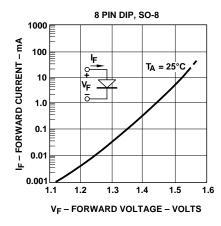
| Parameter | Sym. | Device | Min. | Тур.* | Max. | Units | Test Conditions | Fig. | Note |
|-------------------------------------|------------------|-------------------|------|------------------|------|-------|--|------|-------|
| Momentary Withstand Voltage** | V _{ISO} | 8-Pin DIP SO-8 | 2500 | | | V rms | RH < 50%, t = 1 min., T _A = 25°C | | 6, 14 |
| | I _{I-0} | 8-Pin DIP | | | 1 | μΑ | 45% RH, $t = 5$ s, $V_{I-0} = 3$ kVdc, $T_A = 25$ °C | | 6, 16 |
| Input-Output Resistance | R _{I-0} | 8-Pin DIP SO-8 | | 10 ¹² | | Ω | V _{I-0} = 500 Vdc | | 6 |
| Input-Output Capacitance | C _{I-0} | 8-Pin DIP SO-8 | | 0.6 | | pF | f = 1 MHz | | 6 |

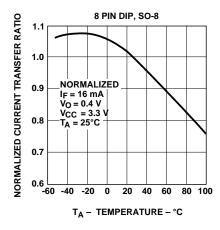
^{*}All typicals at $T_A = 25$ °C.

Notes:

- Derate linearly above 70°C free-air temperature at a rate of 0.8 mA/°C (8-Pin DIP).
 Derate linearly above 85°C free-air temperature at a rate of 0.5 mA/°C (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of 1.6 mA/°C (8-Pin DIP).
 Derate linearly above 85°C free-air temperature at a rate of 1.0 mA/°C (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of 0.9 mW/°C (8-Pin DIP).
 Derate linearly above 85°C free-air temperature at a rate of 1.1 mW/°C (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of 2.0 mW/°C (8-Pin DIP).
 Derate linearly above 85°C free-air temperature at a rate of 2.3 mW/°C (SO-8).
- 5. CURRENT TRANSFER RATIO in percent is defined as the ratio of output collector current, Io, to the forward LED input current, I_F, times 100.
- 6. Device considered a two-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7, and 8 shorted together.
- 7. Common mode transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic High state (i.e., $V_0 > 2.0$ V). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic Low state (i.e., $V_0 < 0.8$ V).
- 8. The 1.9 k Ω load represents 1 TTL unit load of 1.6 mA and the 5.6 mA k Ω pull-up resistor.
- 9. The 4.1 k Ω load represents 1 LSTTL unit load of 0.36 mA and 6.1 k Ω pull-up resistor.
- 10. The frequency at which the AC output voltage is 3 dB below its mid-frequency value.
- 11. The JEDEC registration for the 6N136 specifies a minimum CTR of 15%. Agilent guarantees a minimum CTR of 15%.
- 12. See Option 020 data sheet for more information.
- 13. Use of a 0.1 µf bypass capacitor connected between pins 5 and 8 is recommended.
- 14. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 3000 V rms for 1 second (leakage detection current limit, I₁₋₀ ≤ 5 μA). This test is performed before the 100% Production test shown in the VDE 0884 Insulation Related Characteristics Table, if applicable.
- 15. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 second (leakage detection current limit, I_{I-0} ≤ 5 μA). This test is performed before the 100% Production test shown in the VDE 0884 Insulation Related Characteristics Table, if applicable.
- 16. This rating is equally validated by an equivalent AC proof test.

^{**}The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the VDE 0884 Insulation Related Characteristics Table (if applicable), your equipment level safety specification or Agilent Application Note 1074 entitled "Optocoupler Input-Output Endurance Voltage," publication number 5963-2203F.





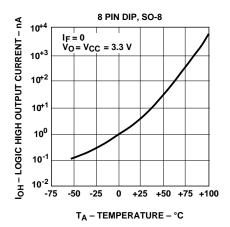


Figure 1. Input current vs. forward voltage.

Figure 2. Current transfer ratio vs. temperature.

Figure 3. Logic high output current vs. temperature.

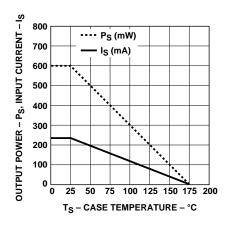


Figure 4. Thermal derating curve, dependence of safety limiting value with case temperature per VDE 0884.

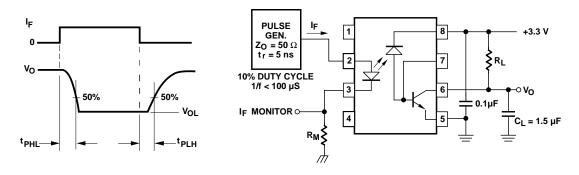


Figure 5. Switching test circuit.

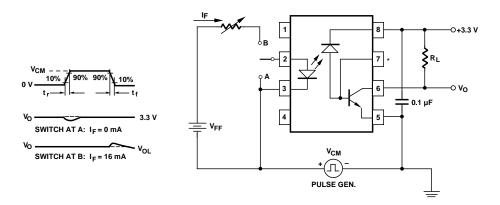


Figure 6. Test circuit for transient immunity and typical waveforms.